

GENERAL PURPOSE HIGH ISOLATION VOLTAGE SINGLE TRANSISTOR TYPE PHOTOCOUPLER SERIES

FEATURES

- 1.Lead forming (gull wing) type, for surface mounting.
- 2. High isolation voltage between input and output (Viso=5000 Vrms).
- 3.Compact dual-in-line package
 - KB847-B: 4-channel type.
- 4. Recognized by UL and CUL, file NO. E225308.
- 5. Approved by VDE 0884 Teil2(NO:40006364)

(Creepage distance between input and output:7mm or more).

DESCRIPTION

- 1.The KB847-B (4-channel) is optically coupled isolators containing a GaAS light emitting diode and an NPN silicon phototransistor.
- 2.The lead pitch is 2.54mm.
- 3. Solid insulation thickness between emitting diode and output phototransistor:>=0.6mm.

APPLICATIONS

- 1.Computer terminals.
- 2. Registers, copiers, automatic vending machines.
- 3. System appliances, measuring instruments.
- 4. Programmable logic controller.
- 5. Signal transmission between circuits of different potentials and impedances.

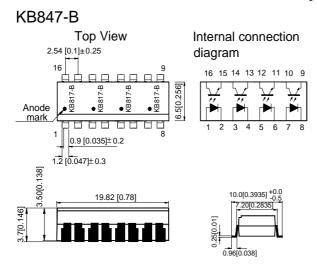
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*PACKAGE DIMENSIONS (UNIT:mm)

Lead Bending Type

TOLERANCE: ±0.5[±0.02] UNLESS OTHERWISE NOTED.



1, 3, 5, 7. Anode 2, 4, 6, 8. Cathode 9, 11, 13, 15. Emitter 10, 12, 14, 16. Collector

*Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	50	mA
	Reverse voltage	V _R	6	V
	Power dissipation	Р	70	mW
Output	Collector-emitter voltage	V _{CEO}	35	V
	Emitter-collector voltage	V _{ECO}	6	٧
	Collector current	I _c	50	mA
	Collector power dissipation	P _C	150	mW
Total power dissipation		Ptot	200	mW
¹¹ Isolation voltage		Viso	5000	Vrms
Operating temperature		Topr	-30~+100	°C
Storage temperature		Tstg	-55~+125	°C
*2Soldering temperature		Tsol	260	°C

 $^{^{*1}}$ 40 to 60% RH,AC for 1 minute.

^{*2} For 10 seconds.



*Electro-optical Characteristics

Parameter		Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input	Forward voltage		VF	I _F =20mA		1.2	1.4	V
	Peak forward voltage		VFM	IFM=0.5A			3.0	V
	Reverse current		I R	V _R =4V			10	μΑ
Output	Collector dark curr	rent	ICEO	Vce=20V,IF=0mA			10 ⁻⁷	nA
Transfer charact- eristics	*1Current transfer r	ratio	CTR	IF=5mA,VcE=5V	50		600	%
	Collector-emitter s	aturation voltage	VCE(sat)	I _F =20mA, I _C =1mA		0.1	0.2	V
	Cut-off frequency		fc	VcE=5V, lc=2mA RL=100Ω,-3dB		80		KHz
	Response time	Rise time	tr	VcE=2V, lc=2mA RL=100Ω		4	18	μs
		Fall time	tf			3	18	μs

*1 Classification table of current transfer ratio is shown below.

$$CTR = \frac{Ic}{I_F} X 100\%$$

Model No.	Rank mark	CTR(%)	
KB847L-B	L	50 to 100	
KB847A-B	А	80 to 160	
KB847B-B	В	130 to 260	
KB847C-B	С	200 to 400	
KB847D-B	D	300 to 600	
KB847AB-B	A or B	80 to 260	
KB847BC-B	B or C	130 to 400	
KB847CD-B	C or D	200 to 600	
KB847AC-B	A,B or C	80 to 400	
KB847BD-B	B,C or D	130 to 600	
KB847AD-B	A,B,C or D	80 to 600	
KB847-B	L,A,B,C,D or No mark	50 to 600	



Fig. 1 Current Transfer Ratio vs. Forward Current

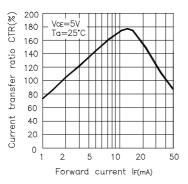


Fig. 3 Collector Current vs.
Collector-emitter Voltage

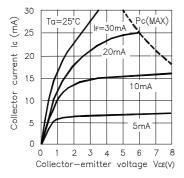


Fig. 5 Collector-emitter Saturation
Voltage vs. Ambient Temperature

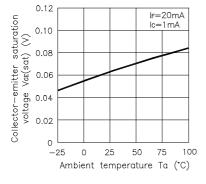


Fig. 2 Forward Current vs. Forward voltage

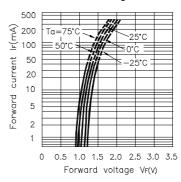


Fig. 4 Relative Current Transfer Ratio vs. Ambient Temperature

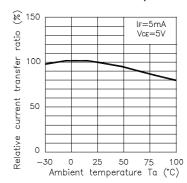
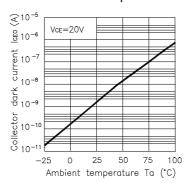


Fig. 6 Collector Dark Current vs.
Ambient Temperature



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Fig. 7 Forward Current vs. **Ambient Temperature**

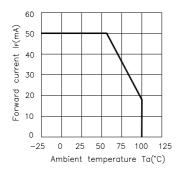


Fig. 8 Collector Power Dissipation vs. **Ambient Temperature**

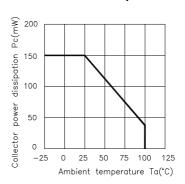
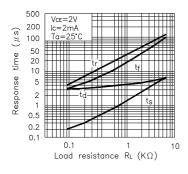


Fig. 9 Response Time vs. Load Resistance



Test Circuit for Response Time

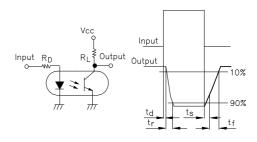
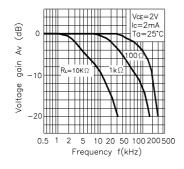
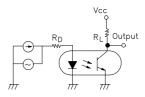


Fig. 10 Frequency Response



Test Circuit for Frequency Response



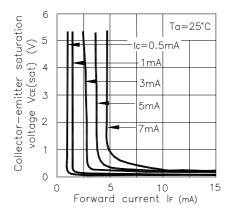
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Fig. 11 Collector-emitter Saturation Voltage vs. Forward Current



*NOTES ON HANDLING

1.Recommended soldering conditions (Dip soldering)

(1) Dip soldering

Temperature 260°C or below (molten solder temperature)

Time Less than 10 seconds.

Cycle One cycle allowed to be dipped in solder including plastic mold portion.

Flux Rosin flux containing small amount of chorine

(The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(2) Cautions

Fluxes

Avovid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that power is suddenly into the componment any surge current may cause damage happen, even if the voltage is within the absolute maximum ratings.



NOTES ON HANDLING

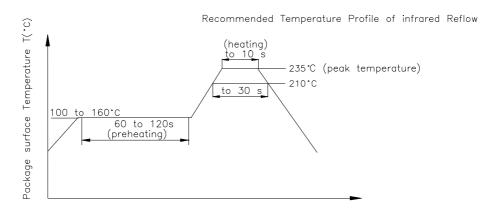
- 1.Recommended soldering conditions
- (1). Infrared reflow soldering
 - •Peak reflow temperature
 - •Time of temperature higher than 210°C
 - Number or reflows
 - ●Flux

235°C or below (package surface temperature)

30 seconds or less

Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2Wt% is recommended.)



CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested.

GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them.

RESTRICTIONS ON PRODUCT USE

- The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices / types available in every country.
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